

Product Standards

Page 2

Contents

| Overview | 3 |
|---|----|
| ■ Features | 3 |
| Applications | 3 |
| Package | 3 |
| ■ Туре | 3 |
| Application Circuit Example | 4 |
| Block Diagram | 5 |
| Pin Descriptions | 6 |
| Absolute Maximum Ratings | 7 |
| Operating Supply Voltage Range | 7 |
| ■ Allowed Voltage and Current Ranges | 8 |
| Electrical Characteristics | 9 |
| Electrical Characteristics (Reference values for design) | 11 |
| ■ Test Circuit Diagram | 12 |
| Electrical Characteristics Test Procedures | 14 |
| Technical Data | 20 |
| Circuit diagrams of the input/output part and pin function descriptions | 20 |
| Control mode (truth table) | 26 |
| Usage Notes | 27 |

| 214407500207110 | | Comission ductor Company, Matsuchite Electric Inductrial Co | امد ا |
|-----------------|---------|---|-------|
| Established | Revised | | |
| 2007-11-12 | | | |

| Product Star | ndards |
|--------------|--------|
|--------------|--------|

30

AN44075A

Driver IC for DC Motor

Overview

AN44075A is a one channel H-bridge driver IC. 1-ch. DC motor can be controlled by a single driver IC.

Features

- Built-in thermal protection and low voltage detection circuit
- Built-in over current protection (when external resistance is added to Pin 7 and Pin 8.)
- Built-in 5 V power supply

Applications

• IC for DC motor drives

Package

- 34 pin Plastic Small Outline Package with Back Heat Sink (SOP Type)
- Туре
 - Bi-CDMOS IC

| 2007-11-12 | | | | | | | |
|-------------|---------|--|--|--|--|--|--|
| Established | Revised | | | | | | |
| | | | | | | | |

| | | I44075A |
|--------------|-------------------|---------|
| Product Star | IDAIDS Total Page | es Page |
| | 30 | 4 |

Application Circuit Example



Note) • This application circuit is shown as an example but does not guarantee the design for mass production set.

| 2007-11-12 | | |
|------------------------------|---------|--|
| Established | Revised | |
| 24 4 4 0 7 5 0 0 4 0 7 4 4 0 | | |

| | AN44 | 075A |
|-------------------|-------------|------|
| Product Standards | Total Pages | Page |
| | 30 | 5 |

Block Diagram



Note) This block diagram is for explaining functions. The part of the block diagram may be omitted, or it may be simplified.

| 2007-11-12 | | |
|-----------------|---------|---|
| Established | Revised | |
| 214407500507110 | | Semiconductor Company, Matsushita Electric Industrial Co., Ltd. |

| | Product Standards | AN44 | 075A |
|--|-------------------|-------------|------|
| | | Total Pages | Page |
| | | 30 | 6 |

Pin Descriptions

| Pin No. | Pin name | Туре | Description |
|---------|----------|----------------|---|
| 1 | VM2 | Power supply | Motor power supply 2 |
| 2 | N.C. | _ | not used |
| 3 | AOUT2 | Output | Motor drive output 2 |
| 4 | N.C. | | not used |
| 5 | N.C. | | not used |
| 6 | N.C. | | not used |
| 7 | RCSA1 | Input / Output | Current detection 1 |
| 8 | RCSA2 | Input / Output | Current detection 2 |
| 9 | GND | Ground | Die pad ground |
| 10 | N.C. | | not used |
| 11 | N.C. | _ | not used |
| 12 | N.C. | _ | not used |
| 13 | N.C. | | not used |
| 14 | AOUT1 | Output | Motor drive output 1 |
| 15 | N.C. | | not used |
| 16 | VM1 | Power supply | Motor power supply 1 |
| 17 | VPUMP | Output | Charge Pump circuit output |
| 18 | BC2 | Output | Charge Pump capacitor connection 2 |
| 19 | BC1 | Output | Charge Pump capacitor connection 1 |
| 20 | N.C. | | not used |
| 21 | N.C. | | not used |
| 22 | VREFA | Input | Peak current setting input |
| 23 | VREFB | Input | Load short threshold input |
| 24 | S5VOUT | Output | Internal reference voltage (5 V output) |
| 25 | GND | Ground | Signal ground |
| 26 | GND | Ground | Die pad ground |
| 27 | SEL | Input | Test mode input |
| 28 | STBY | Input | Standby input |
| 29 | APWM | Input | PWM input |
| 30 | AIN1 | Input | Forward-Reverse input |
| 31 | AIN2 | Input | Brake mode input |
| 32 | NFAULT | Output | Abnormal detection output |
| 33 | N.C. | | not used |
| 34 | TJMON | Output | VBE monitor |

| 2007-11-12 | | |
|-----------------|---------|---|
| Established | Revised | |
| 214407500607110 | | Semiconductor Company, Matsushita Electric Industrial Co., Ltd. |

| | Product Standards | AN44 | 075A |
|--|-------------------|-------------|------|
| | | Total Pages | Page |
| | | 30 | 7 |

Absolute Maximum Ratings

Note) Absolute maximum ratings are limit values which are not destructed, and are not the values to which operation is guaranteed.

| A No. | Parameter | Symbol | Rating | Unit | Note |
|-------|--|---------------------------|-------------|------|--------|
| 1 | Supply voltage1 (Pin 1, Pin 16) | V _M | 37 | V | *1 |
| 2 | Power dissipation | P _D | 0.466 | W | *2 |
| 3 | Operating ambient temperature | T _{opr} | -20 to +70 | °C | *3 |
| 4 | Storage temperature | T _{stg} | -55 to +150 | °C | *3 |
| 5 | Output pin voltage (Pin 3, Pin 14) | V _{OUT} | 37 | V | *4 |
| 6 | Motor drive current (Pin 3, Pin 14) | I _{OUT} | ±3.0 | А | *4, *5 |
| 7 | Flywheel diode current (Pin 3, Pin 14) | \mathbf{I}_{f} | 3.0 | А | *4, *5 |

Notes)*1: The values under the condition not exceeding the above absolute maximum ratings and the power dissipation.

*2 : The power dissipation shown is the value at $T_a = 70^{\circ}$ C for the independent (unmounted) IC package without a heat sink. When using this IC, refer to the P_D - T_a diagram of the package standard and design the heat radiation with sufficient margin so that the allowable value might not be exceeded based on the conditions of power supply voltage, load, and ambient temperature.

*3 : Except for the power dissipation, operating ambient temperature, and storage temperature, all ratings are for $T_a = 25^{\circ}C$.

*4 : Do not apply current or voltage from outside to any pin not listed above.

In the circuit current, (+) means the current flowing into IC and (-) means the current flowing out of IC.

*5 : It is the rating value when connecting the heat sink on the rear face of the package to the ground pattern on the glass epoxy 4-layered PCB. (the ground area in the second and third layer : more than 1 500 mm²)

Operating Supply Voltage Range

| Parameter | Symbol | Range | Unit | Note |
|--------------------------------|----------------|--------------|------|------|
| Operating supply voltage range | V _M | 10.0 to 35.0 | V | * |

Note) * : The values under the condition not exceeding the above absolute maximum ratings and the power dissipation.

| 2007-11-12 | | | |
|-----------------|---------|--|-------|
| Established | Revised | | |
| 214407500707110 | | Operations de stan Operan ann. Mateurabita Ela stria la dustrial Opera | 1.4.4 |

| | AN44 | 075A |
|-------------------|-------------|------|
| Product Standards | Total Pages | Page |
| | 30 | 8 |

Allowed Voltage and Current Ranges

Notes) • Rating Voltage is voltage of pin on GND

• Do not apply current or voltage from outside to any pin not listed below.

| Pin No. | Pin name | Rating | Unit | Note |
|---------|----------|---------------------------|------|------|
| 7 | RCSA1 | +2.5 | V | - |
| 8 | RCSA2 | +2.5 | V | _ |
| 17 | VPUMP | (V _M -2) to 43 | V | _ |
| 18 | BC2 | (V _M -1) to 43 | V | _ |
| 19 | BC1 | V _M + 0.3 | V | _ |
| 22 | VREFA | -0.3 to 6 | V | _ |
| 23 | VREFB | -0.3 to 6 | V | _ |
| 24 | S5VOUT | -7 to 0 | mA | *1 |
| 27 | SEL | -0.3 to 6 | V | _ |
| 28 | STBY | -0.3 to 6 | V | _ |
| 29 | APWM | -0.3 to 6 | V | _ |
| 30 | AIN1 | -0.3 to 6 | V | _ |
| 31 | AIN2 | -0.3 to 6 | V | _ |
| 32 | NFAULT | -0.3 to 6 | V | _ |
| 32 | NFAULT | 4 | mA | _ |

Note) *1 : It is the rating when using with the rang of VM = 16 V to 35 V. When VM = 10 V to 15 V, the rating is -4 mA.

| 2007-11-12 | | |
|-----------------|---------|---|
| Established | Revised | |
| 214407500907110 | | Operational de la companya Material de la destria la destrial de la |

| | | 144075A |
|--------------|-------------------|---------|
| Product Star | IDAIDS Total Page | es Page |
| | 30 | 9 |

Electrical Characteristics at $V_M = 24 \text{ V}$ Note) $T_a = 25^{\circ}\text{C}\pm2^{\circ}\text{C}$ unless otherwise specified.

| В | Demonstern | Or work all | Test | O an alitica a | | Limits | | 1.114 | |
|--------|--|---------------------|----------|--|--------------------------|--------------------------|------|-------|------|
| No. | Parameter | Symbol | circuits | Conditions | Min | Тур | Max | Unit | Note |
| Outp | ut drivers | - | | - | | | | | |
| 1 | High-level output saturation voltage | V _{OH} | 1 | $I_{SA1} = I_{SA2} = -1 A$ | V _M - 0.47 | V _M - 0.36 | _ | v | _ |
| 2 | Low-level output saturation voltage | V _{OL} | 1 | $\mathbf{I}_{\mathbf{SA1}} = \mathbf{I}_{\mathbf{SA2}} = 1 \ \mathbf{A}$ | _ | 0.50 | 0.65 | v | |
| 3 | Flywheel diode forward voltage | V _{DI} | 2 | $I_{DI} = \pm 1 A$ | 0.5 | 1.0 | 1.5 | v | _ |
| 4 | Output leakage current | I _{LEAK} | 1 | $V_{\rm M} = 37 \text{ V}, V_{\rm SRCS} = 0 \text{ V}$ | _ | 10 | 20 | μΑ | |
| Powe | er supply | | | | | | | | |
| 5 | Supply current 1 (Sleep) | I _{M1} | 1 | $V_{STBY} = 0 V$ | | 65 | 105 | μΑ | _ |
| 6 | Supply current 2 (with circuit turned on) | I _{M2} | 1 | $V_{STBY} = 5 V$ | | 7.3 | 12 | mA | _ |
| 7 | Reference voltage | V _{S5VOUT} | 1 | $I_{S5VOUT} = -2.5 \text{ mA}$ | 4.5 | 5.0 | 5.5 | V | |
| 8 | Output impedance | Z _{S5VOUT} | 1 | $\Delta I_{\rm S5VOUT} = -5 \text{ mA}$ | _ | 18 | 27 | Ω | |
| IN inp | but | | | | | | | | |
| 9 | High-level IN input voltage | V _{INH} | 1 | | 2.1 | _ | 5 | V | |
| 10 | Low-level IN input voltage | V _{INL} | 1 | | 0 | _ | 0.6 | v | |
| 11 | High-level IN input current | I _{INH} | 1 | $V_{AIN1} = V_{AIN2} = 5 V$ | -10 | _ | 10 | μΑ | |
| 12 | Low-level IN input current | I _{INL} | 1 | $V_{AIN1} = V_{AIN2} = 0 V$ | -10 | _ | 10 | μΑ | — |
| Stand | dby input | | | | | - | | | |
| 13 | High-level STBY input voltage | V _{STBYH} | 1 | | 2.1 | _ | 5 | v | |
| 14 | Low-level STBY input voltage | V _{STBYL} | 1 | | 0 | _ | 0.6 | v | |
| 15 | High-level STBY input current | I _{STBYH} | 1 | $V_{STBY} = 5 V$ | 30 | _ | 80 | μΑ | |
| 16 | Low-level STBY input current | I _{STBYL} | 1 | $V_{STBY} = 0 V$ | -10 | — | 10 | μΑ | |
| PWM | l input | | | | | | | | |
| 17 | High-level PWM input voltage | V _{PWMH} | 1 | | 2.1 | _ | 5 | v | |
| 18 | Low-level PWM input voltage | V _{PWML} | 1 | | 0 | _ | 0.6 | v | |
| 19 | High-level PWM input current | I _{PWMH} | 1 | $V_{APWM} = 5 V$ | 60 | | 150 | μΑ | |
| 20 | Low-level PWM input current | I _{PWML} | 1 | $V_{APWM} = 0 V$ | -10 | _ | 10 | μΑ | |
| 21 | PWM Input Max frequency | f _{PWM} | 1 | — | _ | — | 200 | kHz | |
| 22 | Input Min pulse width | t _w | 1 | | 2 | | | μs | |

| 2007-11-12 | |
|-------------|---------|
| Established | Revised |

| | AN44 | 075A |
|-------------------|-------------|------|
| Product Standards | Total Pages | Page |
| | 30 | 10 |

Electrical Characteristics (continued) at $V_M = 24 V$ Note) $T_a = 25^{\circ}C \pm 2^{\circ}C$ unless otherwise specified.

| в | Parameter | Symbol | Test | Conditions | | Limits | | Unit | Note |
|------|--------------------------------------|-----------------------------|----------|--|-----|--------|-----|------|------|
| No. | Falameter | Symbol | circuits | Conditions | Min | Тур | Max | Unit | Note |
| Peak | current detection / Over current pro | otection | | | | | | | |
| 23 | Input bias current | I _{REF} | 1 | $V_{REFA} = V_{REFB} = 5 V$ | 83 | 100 | 125 | μA | |
| 24 | PWM frequency | $\mathbf{f}_{\mathrm{PWM}}$ | 1 | $V_{REFA} = 0 V, V_{REFB} = 5 V$ | 17 | 26 | 35 | kHz | — |
| 25 | Pulse blanking time | T _B | 1 | $V_{REFA} = 0 V, V_{REFB} = 5 V$ | 1.5 | 2.5 | 4.5 | μs | |
| 26 | Comp threshold 1 | $VT_{\rm H1}$ | 1 | $V_{REFA} = V_{REFB} = 5 \ V$ | 480 | 500 | 520 | mV | |
| 27 | Comp threshold 2 | VT_{H2} | 1 | $V_{\text{REFA}} = 5.5 \text{ V}, V_{\text{REFB}} = 2.5 \text{ V}$ | 475 | 500 | 525 | mV | |
| 28 | NFAULT output voltage | V _{NFLT} | 1 | $I_{NFLT} = 1 \text{ mA}$ | | — | 0.4 | v | |

| | AN44075A | | | |
|-------------------|-------------|------|--|--|
| Product Standards | Total Pages | Page | | |
| | 30 | 11 | | |

Electrical Characteristics (Reference values for design) at $V_M = 24 V$

Notes) $T_a = 25^{\circ}C \pm 2^{\circ}C$ unless otherwise specified. The characteristics listed below are reference values derived from the design of the IC and are not guaranteed by inspection. If a problem does occur related to these characteristics, we will respond in good faith to user concerns.

| в | Deventer | Currents al | Test | Conditions | Refe | erence va | l la it | Note | |
|------------------------|--|-------------------|----------|--------------|------|-----------|---------|------|------|
| No. | Parameter | Symbol | circuits | Conditions | Min | Тур | Max | Unit | Note |
| Outp | ut drivers | | | | | | | | |
| 29 | Output slew rate 1 | VTr | | Rising edge | | 270 | _ | V/µs | — |
| 30 | Output slew rate 2 | VT_{f} | | Falling edge | _ | 330 | _ | V/µs | _ |
| 31 | Dead time | T _D | | | | 0.45 | _ | μs | — |
| Ther | mal protection | | | | | | | | |
| 32 | Thermal protection operating temperature | TSD _{on} | | | _ | 150 | _ | °C | |
| 33 | Thermal protection hysteresis width | ΔTSD | | | | 40 | _ | °C | |
| Low voltage protection | | | | | | | | | |
| 34 | Protection operating voltage | UVLO1 | | | | 8.0 | _ | V | |
| 35 | Protection release voltage | UVLO2 | _ | | _ | 8.6 | _ | V | _ |

| 2007-11-12 | | |
|-----------------|---------|---|
| Established | Revised | |
| 214407501107110 | | Semiconductor Company, Matsushita Electric Industrial Co., Ltd. |

| | AN44075A | | | |
|-------------------|-------------|------|--|--|
| Product Standards | Total Pages | Page | | |
| | 30 | 12 | | |

Test Circuit Diagram

1. Test Circuit Diagram1



| 2007-11-12 | | |
|-----------------|---------|---|
| Established | Revised | |
| 214407501207110 | | Semiconductor Company, Matsushita Electric Industrial Co., Ltd. |

| | AN44 | 075A |
|-------------------|-------------|------|
| Product Standards | Total Pages | Page |
| | 30 | 13 |

■ Test Circuit Diagram (continued)

2. Test Circuit Diagram2



| C No. | Measuring Pin | Relay Conditions | Voltage Conditions |
|----------|------------------|---------------------|-----------------------|
| NO. | PIN | S6 | I _{DI} |
| | 3 | 1 | 1 A |
| 3 | 5 | 1 | -1 A |
| 3 | 14 | 2 | 1 A |
| | 14 | 2 | -1 A |

| 244407504207440 | | 1.4.1 |
|-----------------|---------|-------|
| Established | Revised | |
| 2007-11-12 | | |

| | AN44 | 075A |
|-------------------|-------------|------|
| Product Standards | Total Pages | Page |
| | 30 | 14 |

Electrical Characteristics Test Procedures

1. Test Circuit 1

| с | Meas | Re | Relay Conditions Voltage Conditions | | | | | | | | | | | | | | | |
|----------------|-------------------|----------|-------------------------------------|-----|-----|-------------------|-------------------|-------------------|-------------------|-------------------|-------------------|-------------------|--------------------------------------|----------------|------------------|------------------|---------------------|---------------------|
| No. | uring Pin | S1 S2 | S3 | S4 | S5 | V _{STBY} | V _{apwm} | V_{AIN1} | V_{AIN2} | V _{REFA} | V_{refb} | V_{SRCS} | V _{SA1} V _{SA2} | V _M | I _{SA1} | I _{SA2} | I _{NFAULT} | I _{S5VOUT} |
| 1 | 3, 14 | 3 | 2 | on | off | 5 V | 5 V | 5 V | 5 V | 5 V | 5 V | 0 V | Hi-Z | 24 V | -1.0 A | 1.0 A | Hi-Z | Hi-Z |
| 2 | 5, 14 | 3 | 2 | on | off | 5 V | 5 V | 0 V | 5 V | 5 V | 5 V | 0 V | Hi-Z | 24 V | 1.0 A | -1.0 A | Hi-Z | Hi-Z |
| 4 | 3, 14 | 1 | 1 | off | off | 5 V | 0 V | 5 V | 5 V | 5 V | 5 V | 0 V | 37 V | 37 V | Hi-Z | Hi-Z | Hi-Z | Hi-Z |
| + | 5, 14 | 1 | 1 | off | off | 5 V | 0 V | 5 V | 0 V | 5 V | 5 V | 0 V | 0 V | 37 V | Hi-Z | Hi-Z | Hi-Z | Hi-Z |
| 5 | 1, 16 | 3 | 2 | on | off | 0 V | 5 V | 5 V | 0 V | 5 V | 5 V | 0 V | Hi-Z | 24 V | Hi-Z | Hi-Z | Hi-Z | Hi-Z |
| 6 | 1, 16 | 3 | 2 | on | off | 5 V | 5 V | 5 V | 0 V | 5 V | 5 V | 0 V | Hi-Z | 24 V | Hi-Z | Hi-Z | Hi-Z | Hi-Z |
| 7 | 24 | 3 | 2 | on | off | 5 V | 5 V | 5 V | 0 V | 5 V | 5 V | 0 V | Hi-Z | 24 V | Hi-Z | Hi-Z | Hi-Z | –2.5 mA |
| 8 | 24 | 3 | 2 | on | off | 5 V | 5 V | 5 V | 0 V | 5 V | 5 V | 0 V | Hi-Z | 24 V | Hi-Z | Hi-Z | Hi-Z | -5 mA |
| 9 17 | 3, 14 | 2 | 2 | on | off | 5 V | 2.1 V | 2.1 V | 2.1 V | 5 V | 5 V | 0 V | Hi-Z | 24 V | Hi-Z | Hi-Z | Hi-Z | Hi-Z |
| 10 17 | 3, 14 | 2 | 2 | on | off | 5 V | 2.1 V | 0.6 V | 2.1 V | 5 V | 5 V | 0 V | Hi-Z | 24 V | Hi-Z | Hi-Z | Hi-Z | Hi-Z |
| 9 18 | 3, 14 | 2 | 2 | on | off | 5 V | 0.6 V | 0.6 V | 2.1 V | 5 V | 5 V | 0 V | Hi-Z | 24 V | Hi-Z | Hi-Z | Hi-Z | Hi-Z |
| 10 18 | 3, 14 | 2 | 2 | on | off | 5 V | 0.6 V | 0.6 V | 0.6 V | 5 V | 5 V | 0 V | Hi-Z | 24 V | Hi-Z | Hi-Z | Hi-Z | Hi-Z |
| 11 15 19 | 28, 29, 30, 31 | 3 | 2 | on | off | 5 V | 5 V | 5 V | 5 V | 5 V | 5 V | 0 V | Hi-Z | 24 V | Hi-Z | Hi-Z | Hi-Z | Hi-Z |
| 12 20 | 29, 30, 31 | 3 | 2 | on | off | 5 V | 0 V | 0 V | 0 V | 5 V | 5 V | 0 V | Hi-Z | 24 V | Hi-Z | Hi-Z | Hi-Z | Hi-Z |
| 13 | 3, 14 | 2 | 2 | on | off | 2.1 V | 5 V | 5 V | 5 V | 5 V | 5 V | 0 V | Hi-Z | 24 V | Hi-Z | Hi-Z | Hi-Z | Hi-Z |
| 14 | 3, 14 | 2 | 2 | on | off | 0.6 V | 5 V | 5 V | 5 V | 5 V | 5 V | 0 V | Hi-Z | 24 V | Hi-Z | Hi-Z | Hi-Z | Hi-Z |
| 16 | 28 | 3 | 2 | on | off | 0 V | 0 V | 0 V | 0 V | 5 V | 5 V | 0 V | Hi-Z | 24 V | Hi-Z | Hi-Z | Hi-Z | Hi-Z |
| 21 | 3 | 2 | 2 | on | off | 5 V | Pulse | 5 V | 5 V | 5 V | 5 V | 0 V | Hi-Z | 24 V | Hi-Z | Hi-Z | Hi-Z | Hi-Z |
| 22 | 3 | 2 | 2 | on | off | 5 V | Pulse | 5 V | 5 V | 5 V | 5 V | 0 V | Hi-Z | 24 V | Hi-Z | Hi-Z | Hi-Z | Hi-Z |
| 23 | 22, 23 | 3 | 2 | on | off | 5 V | 5 V | 5 V | 5 V | 5 V | 5 V | 0 V | Hi-Z | 24 V | Hi-Z | Hi-Z | Hi-Z | Hi-Z |
| 24 | 3 | 2 | 2 | on | on | 5 V | 5 V | 5 V | 5 V | 0 V | 5 V | 1 V | Hi-Z | 24 V | Hi-Z | Hi-Z | Hi-Z | Hi-Z |
| 25 | 3 | 2 | 2 | on | on | 5 V | 5 V | 5 V | 5 V | 0 V | 5 V | 1 V | Hi-Z | 24 V | Hi-Z | Hi-Z | Hi-Z | Hi-Z |
| 26 | 3 | 2 | 2 | on | off | 5 V | 5 V | 5 V | 5 V | 5 V | 5 V | Sweep | Hi-Z | 24 V | Hi-Z | Hi-Z | Hi-Z | Hi-Z |
| 27 | 14 | 2 | 2 | on | off | 5 V | 5 V | 5 V | 5 V | 5.5 V | 2.5 V | Sweep | Hi-Z | 24 V | Hi-Z | Hi-Z | Hi-Z | Hi-Z |
| 28 | 32 | 2 | 2 | on | off | 5 V | 5 V | 5 V | 5 V | 5 V | 0 V | 1 V | Hi-Z | 24 V | Hi-Z | Hi-Z | 1 mA | Hi-Z |

| 2007-11-12 | |
|-------------|---------|
| Established | Revised |

214407501407110

| Product Standards | AN44075A | | |
|-------------------|-------------|------|--|
| Product Standards | Total Pages | Page | |
| | 30 | 15 | |

Electrical Characteristics Test Procedures (continued)

Z_{S5VOUT}

1. Test Circuit 1 (continued)

8) Output impedance



- 9) High-level IN input voltage V_{INH}
- 10) Low-level IN input voltage V_{INI}
- 10) Low-level in input voltage vi_{NL}



Region B

V_{INH}

2.1 V

V_{AIN2}

- SPEC

"H'



Check the conditions by measuring the AOUT1 voltage, AOUT2 voltage with the input voltage set to high level and low level respectively.

Region A : The Power transistor on the flow-in side turned on. Another Power transistor on the flow-out side turned off.

| Region B : | The Power transistor on the flow-in side turned off. |
|------------|--|
| | Another Power transistor on the flow-out side turned on. |

| Measuring | Voltage C | Conditions | Status |
|--------------------|-------------------|-------------------|------------|
| Pin | V _{AIN1} | V _{AIN2} | Status |
| V | 2.1 V | 2.1 V | "H" output |
| V _{AOUT1} | 0.6 V | 2.1 V | "L" output |
| V | 2.1 V | 2.1 V | "L" output |
| V _{AOUT2} | 0.6 V | 2.1 V | "H" output |

Check the conditions by measuring the AOUT1 voltage, AOUT2 voltage with the input voltage set to high level and low level respectively.

Region A : The Power transistor on the flow-in side turned off. Another Power transistor on the flow-out side turned off.

Region B : The Power transistor on the flow-in side turned off. Another Power transistor on the flow-out side turned on.

| Measuring | Voltage C | Conditions | - Status |
|--------------------|-------------------|-------------------|---------------|
| Pin | V _{AIN1} | V _{AIN2} | Status |
| V | 0.6 V | 2.1 V | "H" output |
| V _{AOUT1} | 0.6 V | 0.6 V | "Hi-Z" output |
| V | 0.6 V | 2.1 V | "H" output |
| V _{AOUT2} | 0.6 V | 0.6 V | "Hi-Z" output |

| 2007-11-12 | |
|-------------|---------|
| Established | Revised |

V_{A1}

24 V

12 V

0 V

Region A

SPEC

V_{INL}

0.6 V

"Hi-Z'

214407501507110

Product Standards

AN44075A

Electrical Characteristics Test Procedures (continued)

- 1. Test Circuit 1 (continued)
- 13) High-level STBY input voltage
- 14) Low-level STBY input voltage

V_{STBYH} V_{STBYL}



Check the conditions by measuring the AOUT1 voltage, AOUT2 voltage with the input voltage set to high level and low level respectively.

| Manauring Din | Voltage Conditions | Status |
|--------------------|--------------------|---------------|
| Measuring Pin | V _{STBY} | Status |
| V _{AOUT1} | 0.6 V | "Hi-Z" output |
| V _{AOUT2} | 0.6 V | "Hi-Z" output |
| V _{AOUT1} | 2.1 V | "H" output |
| V _{AOUT2} | 2.1 V | "L" output |

- 17) High-level PWM input voltage
- 18) Low-level PWM input voltage

V_{PWMH} V_{PWML}



Check the conditions by measuring the AOUT1 voltage with the input voltage set to high level and low level respectively.

| Measuring Pin | Voltage Conditions | Status |
|--------------------|--------------------|------------|
| 37 | 0.6 V | "H" output |
| V _{AOUT1} | 2.1 V | "L" output |

Region A : The Power transistor on the flow-in side turned off. Another Power transistor on the flow-out side turned on.

Region B : The Power transistor on the flow-in side turned on. Another Power transistor on the flow-out side turned off.

| Catabliahad Davi | |
|------------------|---------|
| Established Revi | Revised |

Product Standards

AN44075A

Electrical Characteristics Test Procedures (continued)

- 1. Test Circuit 1 (continued)
- 21) PWM Input Max frequency f_{PWM}



24) PWM frequency 1 f_{PWM}

25) Pulse blanking time T_Β

 $T_{\rm B}$

t_{PWM}

$V_{APWM} = Pulse$

Check the conditions by measuring the AOUT2 voltage waveform.

PWM Input Pulse

| | Pulse Conditions | |
|-----------|-------------------|-------------------|
| | V _{APWM} | Input waveform |
| Frequency | 200 kHz | |
| Duty | 40% | S |
| Amplitude | 5 V[p-p] | Square-wave pulse |
| Offset | 2.5 V | |

PWM Input Max Frequency f_{PWM}

Check the conditions by measuring the cycle time of output voltage pulses.

Input Min pulse width tw

Check the conditions by measuring the Duty of output voltage pulses.

The value is obtained from V_{A2} voltage at $V_{\text{REFA}} = 0$ V, $V_{\text{REFB}} = 5$ V, AIN1 = 5 V.

The V_{A2} output waveform is shown below.

PWM Frequency f_{PWM}

Measure the cycle time of output voltage pulses and obtain the value from the following formula.



Pulse blanking time Τ_B Measure the time of $V_{\rm A2}$ output voltage low level.



t[µs]

T_B

 V_{A2} Output waveform

V_{A2}

"H"

"Hi-Z" "L"

| | AN44 | 075A |
|-------------------|-------------|------|
| Product Standards | Total Pages | Page |
| | 30 | 18 |

Electrical Characteristics Test Procedures (continued)

1. Test Circuit 1 (continued)

26) Comp threshold 1 VT_{H1}



Make RCS voltage sweep and measure threshold voltage of output pins.

Region A : Always output "L" Region B : Min. duty, output "L"



27) Comp threshold 2 VT_{H2}



Make RCS voltage sweep and measure threshold voltage of output pins.

Region A : Always output "H" Region B : Output "Hi-Z"

| 2007-11-12 | | Γ | Γ | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
|-------------|---------|---|---|---|--|--|--|--|--|--|--|--|--|--|--|--|--|--|---|--|--|--|--|--|---|--|--|--|--|--|--|--|---|--|--|--|--|--|---|--|--|--|
| Established | Revised |] |] | 1 | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | | | | | | | | | | | | | | | | | | ~ | | | | | | ~ | | | | | | | | _ | | | | | | - | | | |

| | | AN44 | 075A |
|---|------------------|-------------|------|
| P | roduct Standards | Total Pages | Page |
| | | 30 | 19 |

Electrical Characteristics Test Procedures (continued)

- 1. Test Circuit 1 (continued)
- 1) High-level output saturation voltage V_{OH}
- 2) Low-level output saturation voltage V_{OL}



| C No. | Measuring Pin | Current Conditions I _{SA1} , I _{SA2} | Status |
|----------|------------------|--|--|
| 1 | AOUT1 / AOUT2 | -1.0 A | Measure each voltage of the AOUT1 and AOUT2 at (a), (d) above |
| 2 | AOUT1 / AOUT2 | 1.0 A | Measure each voltage of the AOUT1 and AOUT2 at (c) , (b) above |

2. Test Circuit 2

3) Flywheel diode forward voltage V_{DI}

| С | Measuring | Relay Conditions | | | | | |
|--|-----------|--|--|--|--|--|--|
| No. | Pin | S6 | | | | | |
| 3 AOUT1 / AOUT2 Measure the diode voltage at each level on contacts1, 2 of S6. | | Measure the diode voltage at each level on contacts1, 2 of S6. | | | | | |

| 2007-11-12 | | | | | | | | | | | | |
|-----------------|---------|--|--|---|--|---|--|------|--|--|---|--|
| Established | Revised | | | | | | | | | | | |
| 044407504007440 | | | | ~ | | ~ | | | | | ~ | |

| Duratest | Product Standards | AN44075A | | |
|----------|-------------------|-------------|------|--|
| Product | Standards | Total Pages | Page | |
| | | 30 | 20 | |

Technical Data

• Circuit diagrams of the input/output part and pin function descriptions

Note) The characteristics listed below are reference values based on the IC design and are not guaranteed.

| Pin No. | Waveform and voltage | Inner circuit | Impedance | Description |
|-------------------|----------------------|---|-----------|---|
| 3 7 8 14 | | 17 17 100k 100k 100k 100k 100k Pin3 AOUT2 14 AOUT1 100k Pin 7 RCSA1 8 RCSA2 4k m | | Pin 7 : Current detection 1 8 : Current detection 2 3 : Motor drive output 2 14 : Motor drive output 1 |
| 17 18 | | 300k 18 Pin18 BC2 77 125 77 Pin17 VPUMP | | Pin 18 : Charge Pump capacitor 2 17 : Charge Pump circuit output |

| 2007-11-12 | |
|-------------|---------|
| Established | Revised |

| Product Standards | AN44075A | | |
|-------------------|-------------|------|--|
| Product Standards | Total Pages | Page | |
| | 30 | 21 | |

| Pin No. | Waveform and voltage | Inner circuit | Impedance | Description |
|------------|----------------------|---|-----------|-------------------------------------|
| 19 | | 150 150 19 Pin 19 BC1 125 125 19 | | Pin 19 : Charge Pump capacitor 1 |
| 22 | | Pin22 VREFA | 50 kΩ | Pin 22 : Peak current setting input |

| 2007-11-12 | | |
|-----------------|---------|--|
| Established | Revised | |
| 214407502107110 | | Semiconductor Company, Matsushita Electric Industrial Co., Ltd |

| | AN44075A | | |
|-------------------|-------------|------|--|
| Product Standards | Total Pages | Page | |
| | 30 | 22 | |



| 2007-11-12 | | |
|-----------------|---------|--|
| Established | Revised | |
| 214407502207110 | | Semiconductor Company, Matsushita Electric Industrial Co., Ltd |

| Product Standards | AN44 | 075A |
|-------------------|-------------|------|
| Product Standards | Total Pages | Page |
| | 30 | 23 |

| Pin No. | Waveform and voltage | Inner circuit | Impedance | Description |
|------------|----------------------|--|-----------|--|
| 28 | | Pin28 STBY | 100 kΩ | Pin 28 : Standby input |
| 27 29 | | Pin27 SEL 29 APWM 4k 50k 50k 100k | 54 kΩ | Pin 27 : Test mode input 29 : PWM input |

| 2007-11-12 | | |
|-----------------|---------|---|
| Established | Revised | |
| 214407502307110 | | Semiconductor Company, Matsushita Electric Industrial Co., Ltd. |

| | AN44 | 075A |
|-------------------|-------------|------|
| Product Standards | Total Pages | Page |
| | 30 | 24 |

| Pin No. | Waveform and voltage | Inner circuit | Impedance | Description |
|------------|----------------------|-------------------------------------|-----------|---|
| 30 31 | | Pin30 AIN1 31 AIN2 4k 100k | | Pin 30 : Forward / Reverse input 31 : Brake mode input |
| 32 | | (32) Pin32 NFAULT | | Pin 32 : Abnormal detection output |

| 2007-11-12 | | |
|-----------------|---------|---|
| Established | Revised | |
| 214407502407110 | | Semiconductor Company, Matsushita Electric Industrial Co., Ltd. |

| | AN44 | 075A |
|-------------------|-------------|------|
| Product Standards | Total Pages | Page |
| | 30 | 25 |

| Pin No. | Waveform and voltage | Inner circuit | Impedance | Description |
|-------------|----------------------|---|-----------|----------------------|
| 34 | | Pin34 TJMON (34) | | Pin 34 : VBE monitor |
| Sym bols | | ✓ S5VOUT (Pin 24) ✓ VM (Pin 1, Pin 16) ✓ Diode ✓ Zener diode ✓ Ground | | |

| 2007-11-12 | | |
|-----------------|---------|---|
| Established | Revised | |
| 214407502507110 | | Semiconductor Company, Matsushita Electric Industrial Co., Li |

| Due du et Oten de rele | AN44 | 075A |
|------------------------|-------------|------|
| Product Standards | Total Pages | Page |
| | 30 | 26 |

Technical Data (continued)
 Control mode (truth table)

| INPUT | | | | | OUTPUT | |
|-------|------|------|------|-------|--------|-------------|
| STBY | AIN1 | AIN2 | APWM | AOUT1 | AOUT2 | Mode |
| | _ | "H" | "L" | "H" | "H" | Short Brake |
| "H" | "L" | _ | "H" | "L" | "H" | Forward |
| н | "H" | | "H" | "H" | "L" | Reverse |
| | | "L" | "L" | OFF | OFF | Stop |
| "L" | | | _ | OFF | OFF | Standby |

| INPUT | OUTPUT | |
|-------|------------------|--|
| SEL | Mode | |
| "H" | Short Detect off | |
| "L" | Short Detect on | |

| 2007-11-12 | | |
|-----------------|---------|---|
| Established | Revised | |
| 214407502607110 | | Semiconductor Company, Matsushita Electric Industrial Co., Ltd. |

| | Product Standards | AN44 | 075A |
|--|-------------------|-------------|------|
| | | Total Pages | Page |
| | | 30 | 27 |

Usage Notes

Special attention and precaution in using

1. This IC is intended to be used for general electronic equipment [DC motor with brass].

- Consult our sales staff in advance for information on the following applications:
- Special applications in which exceptional quality and reliability are required, or if the failure or malfunction of this IC may directly jeopardize life or harm the human body.
- Any applications other than the standard applications intended.
 - (1) Space appliance (such as artificial satellite, and rocket)
 - (2) Traffic control equipment (such as for automobile, airplane, train, and ship)
 - (3) Medical equipment for life support
 - (4) Submarine transponder
 - (5) Control equipment for power plant
 - (6) Disaster prevention and security device
 - (7) Weapon
 - (8) Others : Applications of which reliability equivalent to (1) to (7) is required
- 2. Pay attention to the direction of LSI. When mounting it in the wrong direction onto the PCB (printed-circuit-board), it might smoke or ignite.
- 3. Pay attention in the PCB (printed-circuit-board) pattern layout in order to prevent damage due to short circuit between pins. In addition, refer to the Pin Description for the pin configuration.
- 4. Perform a visual inspection on the PCB before applying power, otherwise damage might happen due to problems such as a solderbridge between the pins of the semiconductor device. Also, perform a full technical verification on the assembly quality, because the same damage possibly can happen due to conductive substances, such as solder ball, that adhere to the LSI during transportation.
- Take notice in the use of this product that it might break or occasionally smoke when an abnormal state occurs such as output pin-V_M short (Power supply fault), output pin-GND short (Ground fault), output-to-output-pin short (load short) or the leakage between pins.

Pay special attention to the following pins so that are not short-circuited with the V_M pin, ground pin, other output pins or RCS pin.

(1) AOUT1 (Pin 14), AOUT2 (Pin 3)

(2) BC1 (Pin 19), BC2 (Pin 18), VPUMP (Pin 17)

(3) VM1 (Pin 16), VM2 (Pin 1), S5VOUT (Pin 24)

(4) RCSA1 (Pin 7), RCSA2 (Pin 8)

And, safety measures such as an installation of fuses are recommended because the extent of the above-mentioned damage and smoke emission will depend on the current capability of the power supply.

- 6. When using the LSI for new models, verify the safety including the long-term reliability for each product.
- 7. When the application system is designed by using this LSI, be sure to confirm notes in this book.
- Be sure to read the notes to descriptions and the usage notes in the book.
- 8. Please connect the metallic plate (fin) on the back side of the IC with the GND potential (the pattern for cooling).
- 9. The protection circuit is for maintaining safety against abnormal operation. Therefore, the protection circuit should not work during normal operation.

Especially the thermal protection circuit might be damaged before it could operate if the area of safety operation of the device or the absolute maximum rating is instantaneously exceeded due to the output pin to V_M short (Power supply fault), or output pin to GND short (Ground fault).

- 10. Unless specified in the product specifications, make sure the negative voltage or excessive voltage are not applied to the pins because the device might be damaged, which could happen due to negative voltage or excessive voltage generated during the ON and OFF timing when the inductive load of a motor coil, optical pick-up or transformer is being driven.
- 11. The product which has specified ASO (Area of Safe Operation) should be operated in ASO.
- 12. Check the risk that is caused by the failure of external components.

| 2007-11-12 | | |
|-----------------|---------|--|
| Established | Revised | |
| 044403500303440 | | |

| | AN44075A | | |
|-------------------|-------------|------|--|
| Product Standards | Total Pages | Page | |
| | 30 | 28 | |

Usage Notes (continued)

- 13. Perform thermal design work with consideration of a sufficient margin to keep the power dissipation based on supply voltage, load, and ambient temperature conditions.
- (The IC is recommended that junctions are designed below 70% to 80% of Absolute Maximum Rating.)
- 14. Set the values of the capacitor between the VPUMP and GND pins so that the voltage on the VPUMP (Pin 17) will not transiently exceed 43 V in the transition from motor standby to motor start.
- 15. This IC employs a PWM drive method that switches the high-current output of the output transistor. Therefore, the IC is apt to generate noise that may cause the IC to malfunction or have fatal damage. To prevent these problems, the power supply must be stable enough. Therefore, the capacitance between the S5VOUT and GND pins must be a minimum of 0.1 μF and the one between the VM and GND pins must be a minimum of 47 μF and as close as possible to the IC so that PWM noise will not cause the IC to malfunction or have fatal damage.
- 16. A high current flows into the IC. Therefore, the common impedance of the PCB pattern cannot be ignored. Take the following points into consideration and design the PCB pattern of the motor.

A high current flows into the line between the VM1 (Pin 16) and VM2 (Pin 1) pins. Therefore, noise is generated with ease at the time of switching due to the inductance (L) of the line, which may result in the malfunctioning or destruction of the IC (see the circuit diagram 1). As shown in the circuit diagram 2, the escape way of the noise is secured by connecting a capacitor to the connector close to the VM pin of the IC. This makes it possible to suppress the direct VM pin voltage of the IC. Make the settings as shown in the circuit diagram 2 as much as possible.



Diagram 1. Unrecommended pattern



Diagram 2. Recommended pattern

17. In the case of measuring the chip temperature of the IC, measure the voltage of TJMON (Pin 34) and presume chip temperature from following data. Use the following data as reference data. Before applying the IC to a product, conduct a sufficient reliability test of the IC along with the evaluation of the product with the IC incorporated.



Semiconductor Company, Matsushita Electric Industrial Co., Ltd.

| | Draduat Standarda | AN44075A | | |
|-------------------|-------------------|----------|----|--|
| Product Standards | Total Pages | Page | | |
| | | 30 | 29 | |

Usage Notes (continued)

18. Power Supply Sequence

Rise/Fall slew rate are designed , VM : below $0.1V/\mu s$.



19. Charge pump circuit

1

The charge pump circuit has stopped when the Low signal is input to STBY(Pin 28).

The start time is necessary until the charge pump circuit begins operating. Please take the wait time of $200 \ \mu s$ or more until the motor starts rotating after making IC active.

| VM + 5 V VM - 1.4 V | VPUMP | | _ |
|------------------------|------------|----------------|------|
| | Delay : 2 | 200 µs or more | |
| "H" "L" | PWM input | | _ |
| "H" "I " | STBY input | | _ |
| <u>"L"</u> | Į | | time |

20. PWM operation

When Free Run Mode and Forward/Reverse Mode is repeated in PWM operation, the backflow current flows from GND toward VM in Free Run Mode. Please add external capacity so as not to exceed the absolute maximum rating of VM. Also, when Free Run Mode and Forward/Reverse Mode is repeated in PWM operation, the duty of the output is extremely

different from the duty of the input.

21. Thermal protection circuit

The operation point and hysteresis of the thermal protection circuit of the IC have about $\pm 10^{\circ}$ C of variation.

Also, the protection circuit is incorporated for the purpose of securing safety if the IC malfunctions. Therefore design a protection circuit so that a protection circuit will not operate under a normal operating condition.

22. Low voltage detection circuit

The threshold of low voltage detection circuit of the IC is below,

Detection voltage (UVLO1) : Min = 7.1 V

Release voltage (UVLO2) : Max = 9.5 V

In case of less than the detection voltage, the power transistor of the motor output pins (AOUT1, AOUT2) on the flow-in side and another power transistor on the flow-out side turn off.



| 214407502007110 | | Question a duration Queen and Mathematics Flucture la duratical Qu | امد ا |
|-----------------|---------|--|-------|
| Established | Revised | | |
| 2007-11-12 | | | |

| | Product Standards | AN44075A | |
|--|-------------------|-------------|------|
| | | Total Pages | Page |
| | | 30 | 30 |

Usage Notes (continued)

23. Operation within Supply Voltage Range

About Parameters from No.9 to No.28 in Electrical Characteristics, It is possible to gain characteristics described in Electrical Characteristics if operating within Supply Voltage Range (10 V to 35 V).

24. Temperature dependence of output impedance of motor drive output pins

Output impedance of motor drive output pins (Pin 3, 14) have temperature dependence below.

The characteristics below are reference values derived from the design of the IC and are not guaranteed by inspection. Conduct a sufficient reliability test of the IC along with the evaluation of the product with the IC incorporated.



25. No connected pins

When no connected pins (Pin 2, 4, 6, 13, 15, 20, 33) are connected to the GND pin, adjacent pin short or reverse insertion may cause destruction and smoke generation. Therefore, design the PCB pattern so that the above no connected pins are opened on the PCB pattern. There is no problem that no connected pins (Pin5, 10, 11, 12, 21) except for the above-mentioned pins are connected to the GND pin.

26. AOUT1 and AOUT2 pins after operation of the protection circuit of the IC

0

This IC has built-in thermal protection circuit, low voltage detection circuit and over current detection circuit.

AOUT1 and AOUT2 pins operate as below after each protection circuit operates,

Thermal protection circuit : In operating, the power transistor of AOUT1 and AOUT2 pins on the flow-in side and another power transistor on the flow-out side turn off. If the temperature of the IC lowers above thermal protection hysteresis width, AOUT1 and AOUT2 pins recover in normal operation automatically.

Low voltage detection circuit : In operating, the power transistor of AOUT1 and AOUT2 pins on the flow-in side and another power transistor on the flow-out side turn off. If VM pin voltage exceeds protection release voltage, AOUT1 and AOUT2 pins recover in normal operation automatically.

Over current detection circuit : In operating, the power transistor of AOUT1 and AOUT2 pins on the flow-in side and another power transistor on the flow-out side turn off, and keep this status latched. If over current detection circuit operates, reset the circuit by inputting low voltage to STBY pin or setting VM pin voltage to less than protection operating voltage.

27. Peak current detection and over current detection

Peak current detection values and over current detection values are obtained by following formula.

- Ipeak1 = $0.1 \times VREFA / RCS[A]$
- Ipeak2 = $0.2 \times VREFB / RCS[A]$
- Ipeak1 : Peak current detection value
- Ipeak2 : Over current detection value
- VREFA : VREFA pin applied voltage
- VREFB : VREFB pin applied voltage
- $RCS: RCSA1 \, / \, resistive \, connection \, between \, RCSA2 \, and \, GND \, pins$

2007-11-12EstablishedRevised

| Regulations No. | . 50350820 | | | Total Page | s Page |
|-----------------|----------------|------------|-----------------|-------------|--------|
| | . 30330829 | | | 6 | 1 |
| | | | | | |
| | | | | | |
| | | | | | |
| | | | | | |
| | | | | | |
| | | | | | |
| Г | | | | | |
| | | | | | |
| | PACK | AGE S | STAND | ARDS | |
| | | | | | |
| | | | | | |
| Г | | | | | |
| | Package Co | de | HSOP034-P | -0300A | |
| | | | | | |
| | | | | | |
| | | | | | |
| | | | | | |
| | | | | | |
| | | | | | |
| | | | | | |
| | | | | | |
| | | | | | |
| | | | | | |
| | | Semiconduc | tor Company | | |
| | Mats | | Industrial Co., | Ltd. | |
| | | | | | |
| | Established by | Applied by | Checked by | Prepared by | |
| | | | | | |
| | K.Komichi | H.Yoshida | M.Okajima | M.Itoh | |
| | | | | | |
| | · | | | | |
| | | | | | |
| | | | | | |
| | | | | | |
| | | | | | |
| | | | | | |

1. Outline Drawing

Unit:mm



| | Body Material | : Epoxy Resin |
|----------|---------------------------|--------------------------------|
| | Lead Material | : Cu Alloy |
| | Lead Finish Met | hod : Pd Plating |
| | | |
| Semicond | luctor Company, Matsushit | a Electric Industrial Co., Ltd |

| Total Pages | Page |
|-------------|------|
| 6 | 3 |

2. Package Structure (Technical Report : Reference Value)

| Chip Material Leadframe material Inner lead surface | | Si | 1 | |
|---|----------|----------------------------|-----|--|
| | | Cu alloy | 2 | |
| | | Pd plating | 3 | |
| Outer lead surface | | Pd plating | 4 | |
| Chip mount | Method | Resin adhesive method | (5) | |
| | Material | Adhesive material | | |
| Wirebond | Method | Thermo-compression bonding | 6 | |
| Wilebolia | Material | Au | 6 | |
| Molding | Method | Transfer molding | | |
| Molding | Material | Epoxy resin | | |
| Mass | | 250 mg | | |



| PACKAGE STANDARDS | | |
|-------------------|-------------|------|
| | Total Pages | Page |
| HSOP034-P-0300A | | 4 |

3. Mark Drawing



4. Power Dissipation (Technical Report)



5. Power Dissipation (Supplementary Explanation)

[Experiment environment]

Power Dissipation (Technical Report) is a result in the experiment environment of SEMI standard conformity. (Ambient air temperature (Ta) is 25 degrees C)

[Supplementary information of PWB to be used for measurement]

The supplement of PWB information for Power Dissipation data (Technical Report) are shown below.

| Indication | Total Layer | Resin Material |
|-------------|-------------|----------------|
| Glass-Epoxy | 1-layer | FR-4 |
| 4-layer | 4-layer | FR-4 |

[Notes about Power Dissipation (Thermal Resistance)]

Power Dissipation values (Thermal Resistance) depend on the conditions of the surroundings, such as specification of PWB and a mounting condition, and a ambient temperature. (Power Dissipation (Thermal Resistance) is not a fixed value.)

The Power Dissipation value (Technical Report) is the experiment result in specific conditions (evaluation environment of SEMI standard conformity), and keep in mind that Power Dissipation values (Thermal resistance) depend on circumference conditions and also change.

[Definition of each temperature and thermal resistance]

Ta : Ambient air temperature

The temperature of the air is defined at the position where the convection, radiation, etc. don't affect the temperature value, and it's separated from the heating elements.

- Tc : It's the temperature near the center of a package surface. The package surface is defined at the opposite side if the PWB.
- Tj : Semiconductor element surface temperature (Junction temperature.)
- Rth(j-c) : The thermal resistance (difference of temperature of per 1 Watts) between a semiconductor element junction part and the package surface
- Rth(c-a) : The thermal resistance (difference of temperature of per 1 Watts) between the package surface and the ambient air

Rth(j-a) : The thermal resistance (difference of temperature of per 1 Watts) between a semiconductor element junction part and the ambient air

